

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE30H11BK uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

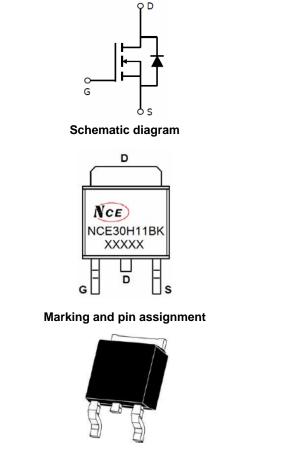
General Features

- V_{DS} =30V,I_D =110A
 R_{DS(ON)} =2.6mΩ (typical) @ V_{GS}=10V
 R_{DS(ON)} =4.5mΩ (typical) @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- DC/DC converters
- Synchronous Rectifier

100% UIS TESTED!



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30H11BK	NCE30H11BK	TO-252-2L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	110	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	77.8	A
Pulsed Drain Current	I _{DM}	440	A
Maximum Power Dissipation	П	115	W
Derating factor	— P _D	0.77	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	300	mJ
Operating Junction and Storage Temperature Range	T_{J},T_{STG}	-55 To 175	്റ

Thermal Characteristic

	Thermal Resistance, Junction-to-Case ^(Note 2)	R _{ejc}	1.36	°C/W
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Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics				•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =30V, V_{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)				•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1	1.5	2.2	V	
Durain Course On Chate Desintence	D	V_{GS} =10V, I _D =20A	-	2.6	4.0	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =4.5V, I _D =20A		4.5	8.0		
Forward Transconductance	g fs	V _{DS} =5V,I _D =20A	20	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	3009	-	PF	
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	451	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	403	-	PF	
Switching Characteristics (Note 4)	·		•				
Turn-on Delay Time	t _{d(on)}		-	11	-	nS	
Turn-on Rise Time	tr	V _{DD} =15V,I _D =20A	-	14	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	36	-	nS	
Turn-Off Fall Time	t _f		-	12	-	nS	
Total Gate Charge	Qg)/ _15)/1 _204	-	66.3	-	nC	
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =20A,	-	7.0	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	17.2	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V	
Diode Forward Current (Note 2)	ls		-	-	110	А	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	29	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	32	-	nC	

Notes:

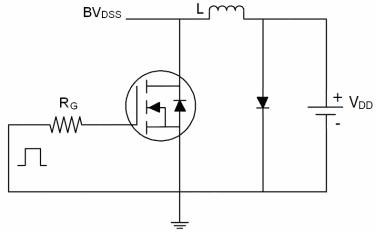
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C, V_{DD}=15V,V_G=10V,L=0.5mH, Rg=25 Ω ;



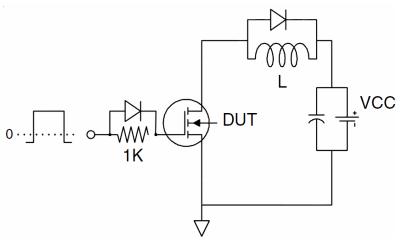
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Test Circuit

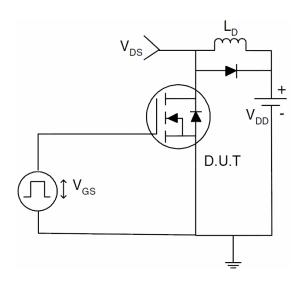
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

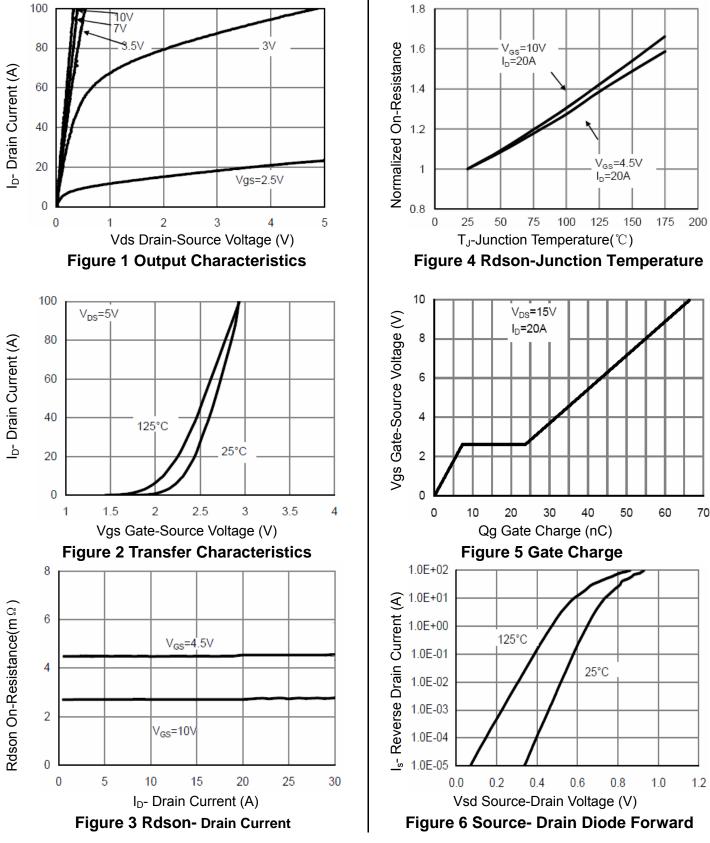


3) Switch Time Test Circuit





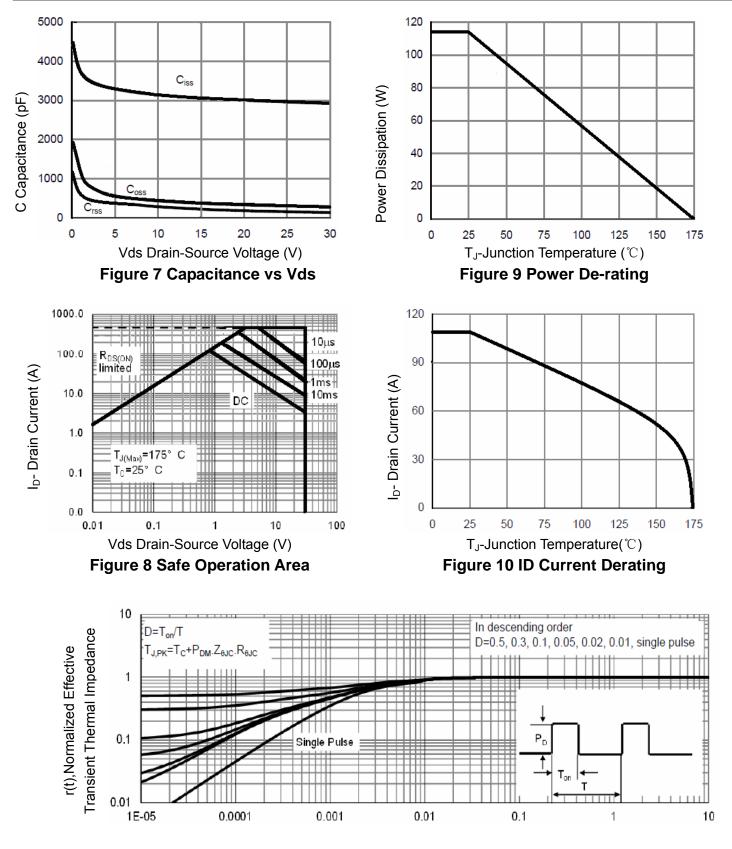






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NCE30H11BK

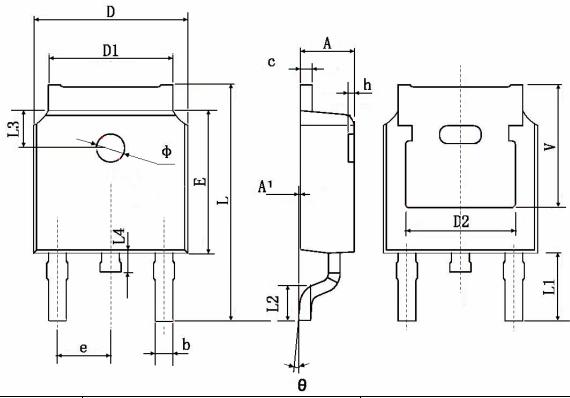


Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



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TO-252-2L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.48	0.483 TYP.) TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.90	0 TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	0 TYP.	0.211 TYP.		



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